

L-7104ZGC-G

T-1 (3mm) Solid State Lamp

DESCRIPTIONS

- The Green source color devices are made with InGaN Light Emitting Diode
- · Electrostatic discharge and power surge could damage the LEDs
- It is recommended to use a wrist band or anti-electrostatic glove when handling the LEDs
- All devices, equipments and machineries must be electrically grounded

FEATURES

- · Low power consumption
- Popular T-1 diameter package
- · General purpose leads
- · Reliable and rugged
- · Long life solid state reliability
- · Available on tape and reel
- · RoHS compliant

APPLICATIONS

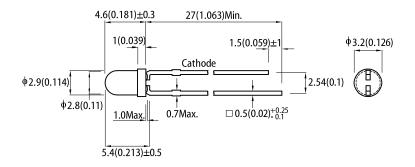
- · Status indicator
- Illuminator
- · Signage applications
- · Decorative and entertainment lighting
- · Commercial and residential architectural lighting

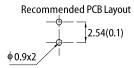
ATTENTION

Observe precautions for handling electrostatic discharge sensitive devices



PACKAGE DIMENSIONS





- All dimensions are in millimeters (inches).
 Tolerance is ±0.25(0.01") unless otherwise noted.

- Lead spacing is measured where the leads emerge from the package.
 The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice

SELECTION GUIDE

Part Number	Emitting Color	Lens Type	Iv (mcd) @ 20mA [2]		Viewing Angle [1]
rait Number	(Material)	Lens Type	Min.	Тур.	201/2
L-7104ZGC-G	■ Green (InGaN)	Water Clear	8000	14000	30°

1. 61/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value 2. Luminous intensity / luminous flux: +/-15%.

3. Luminous intensity value is traceable to CIE127-2007 standards.





ELECTRICAL / OPTICAL CHARACTERISTICS at T_A=25°C

Parameter	Symbol	Emitting Color	Value		Unit
Farameter	Symbol	Emitting Color	Тур.	Max.	Uill
Wavelength at Peak Emission I _F = 20mA	λ_{peak}	Green	520	-	nm
Dominant Wavelength I _F = 20mA	λ _{dom} ^[1]	Green	525	-	nm
Spectral Bandwidth at 50% Φ REL MAX I _F = 20mA	Δλ	Green	35	-	nm
Capacitance	С	Green	100	-	pF
Forward Voltage I _F = 20mA	V _F ^[2]	Green	3.2	4.0	V
Reverse Current (V _R = 5V)	I _R	Green	-	50	uA

Notes:

ABSOLUTE MAXIMUM RATINGS at T_A=25°C

Parameter	Symbol	Value	Unit	
Power Dissipation	P _D	120	mW	
Reverse Voltage	V_R	5	V	
Junction Temperature	T _j	115	°C	
Operating Temperature	T _{op}	-40 to +85	°C	
Storage Temperature	T _{stg}	-40 to +85	°C	
DC Forward Current	l _F	30	mA	
Peak Forward Current	I _{FM} ^[1]	100	mA	
Electrostatic Discharge Threshold (HBM)	-	450	V	
Lead Solder Temperature [2]		260°C For 3 Seconds		
Lead Solder Temperature [3]		260°C For 5 Seconds		

Notes:
1. 1/10 Duty Cycle, 0.1ms Pulse Width.
2. 2mm below package base.
3. 5mm below package base.
4. Relative humidity levels maintained between 40% and 60% in production area are recommended to avoid the build-up of static electricity – Ref JEDEC/JESD625-A and JEDEC/J-STD-033.

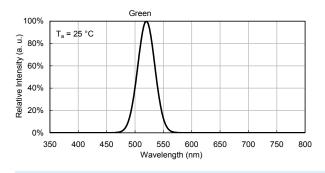


The dominant wavelength (λd) above is the setup value of the sorting machine. (Tolerance λd:±1nm.)
 Forward voltage:±0.1V.
 Wavelength value is traceable to CIE127-2007 standards.
 Excess driving current and / or operating temperature higher than recommended conditions may result in severe light degradation or premature failure.

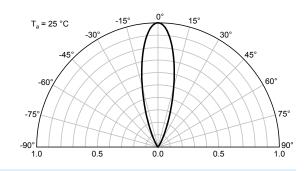


TECHNICAL DATA

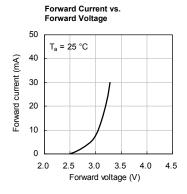
RELATIVE INTENSITY vs. WAVELENGTH

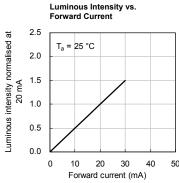


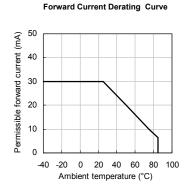
SPATIAL DISTRIBUTION

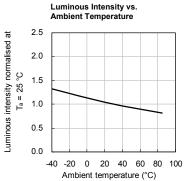


GREEN

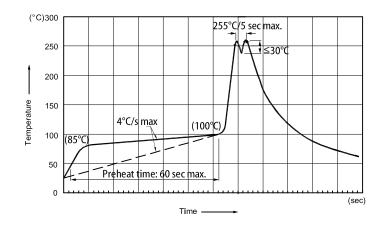








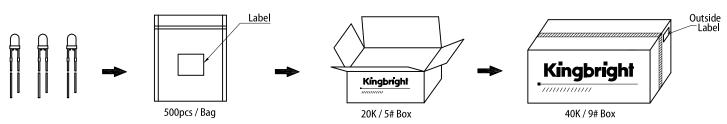
RECOMMENDED WAVE SOLDERING PROFILE



- Notes:
 1. Recommend pre-heat temperature of 105°C or less (as measured with a thermocouple attached to the LED pins) prior to immersion in the solder wave with a maximum solder bath temperature of 260 $^{\circ}\mathrm{C}$
- 2. Peak wave soldering temperature between 245°C ~ 255°C for 3 sec (5 sec max).
- 3. Do not apply stress to the epoxy resin while the temperature is above 85°C.
 4. Fixtures should not incur stress on the component when mounting and during soldering process.

- 5. SAC 305 solder alloy is recommended.6. No more than one wave soldering pass.

PACKING & LABEL SPECIFICATIONS









PRECAUTIONS

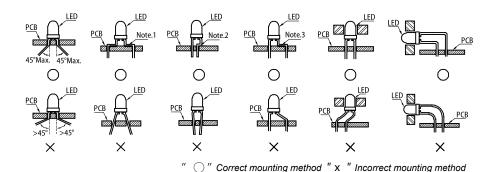
Storage conditions

- 1. Avoid continued exposure to the condensing moisture environment and keep the product away from rapid transitions in ambient
- 2. LEDs should be stored with temperature ≤ 30°C and relative humidity < 60%.
- 3. Product in the original sealed package is recommended to be assembled within 72 hours of opening. Product in opened package for more than a week should be baked for 30 (+10/-0) hours at 85 ~ 100°C.

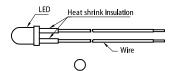
LED Mounting Method

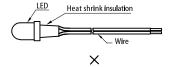
1. The lead pitch of the LED must match the pitch of the mounting holes on the PCB during component placement. Lead-forming may be required to insure the lead pitch matches the hole pitch. Refer to the figure below for proper lead forming procedures.

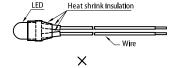
Note 1-3: Do not route PCB trace in the contact area between the leadframe and the PCB to prevent short-circuits.

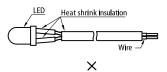


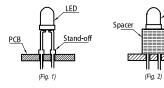
2. When soldering wires to the LED, each wire joint should be separately insulated with heat-shrink tube to prevent short-circuit contact. Do not bundle both wires in one heat shrink tube to avoid pinching the LED leads. Pinching stress on the LED leads may damage the internal structures and cause failure.









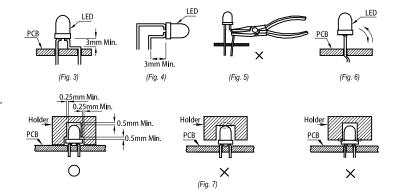


- 3. Use stand-offs (Fig.1) or spacers (Fig.2) to securely position the LED above the PCB.
- 4. Maintain a minimum of 3mm clearance between the base of the LED lens and the first lead bend (Fig. 3, Fig. 4).
- 5. During lead forming, use tools or jigs to hold the leads securely so that the bending force will not be transmitted to the LED lens and its internal structures. Do not perform lead forming once the component has been mounted onto the PCB. (Fig. 5)



Lead Forming Procedures

- 1. Do not bend the leads more than twice. (Fig. 6)
- 2. During soldering, component covers and holders should leave clearance to avoid placing damaging stress on the LED during soldering. (Fig. 7)
- 3. The tip of the soldering iron should never touch the lens epoxy.
- 4. Through-hole LEDs are incompatible with reflow soldering.
- 5. If the LED will undergo multiple soldering passes or face other processes where the part may be subjected to intense heat, please check with Kingbright for compatibility.



PRECAUTIONARY NOTES

- The information included in this document reflects representative usage scenarios and is intended for technical reference only.
- The part number, type, and specifications mentioned in this document are subject to future change and improvement without notice. Before production usage customer should refer to the latest datasheet for the updated specifications.
- When using the products referenced in this document, please make sure the product is being operated within the environmental and electrical limits specified in the datasheet. If customer usage exceeds the specified limits, Kingbright will not be responsible for any subsequent issues.
- The information in this document applies to typical usage in consumer electronics applications. If customer's application has special reliability requirements or have life-threatening liabilities, such as automotive or medical usage, please consult with Kingbright representative for further assistance.
- The contents and information of this document may not be reproduced or re-transmitted without permission by Kingbright
- All design applications should refer to Kingbright application notes available at http



X-ON Electronics

Largest Supplier of Electrical and Electronic Components

Click to view similar products for Standard LEDs - SMD category:

Click to view products by Kingbright manufacturer:

Other Similar products are found below:

LTST-C19GD2WT LTST-N683GBEW 597-3006-607F 597-3403-607F LTW-K140SZR40 LTW-M140ZVS 598-8110-100F 598-8170-100F 598-8610-202F 7012X7 AAAF5060QBFSEEZGS 12-22SURSYGC/S530-A3/E2/TR8 1383SURT/S530-A3/TR1(R) APT1608QGW EASV1803BA0 SML310BATT86 SML-512VWT86A SML-LX0606SISUGC/A SML-LXL1307SRC-TR SML-LXR851SIUPGUBC LT1ED53A 17-21/G6C-FM1N2B/3T FAT801-S SSL-LXA227IC-TR31A AM27ZGC03 APB3025SGNC APHK1608VGCA APT2012QGW CLMVC-FKA-CA1E1L81BB7C3C3 CLYBA-FKA-CFHHKL9BBB7A363 CMD11504UR LTW-020ZDCG LTW-21TS5 LTW-K140SZR30 HSMY-C177 UYGT801-S KVH1C100MF6R 42-21SYGC/S530-E1/TR8 YGFR411-H 597-2311-402F 597-2712-602F 5973212407NF 597-3302-607F 597-5202-407F 598-8330-117F SAW8WA2A-L35M40-CA SML013WBDW1 SML-LX0402IC-TR CLMVC-FKA-CLBDGL7LBB79353 VLMKG3400-GS08